Unit: mm

TOSHIBA Field Effect Transistor Silicon P Channel MOS Type (L^2 - π -MOSV)

2SJ507

Chopper Regulator, DC-DC Converter and Motor Drive Applications

• 4 V gate drive

• Low drain–source ON resistance : R_{DS} (ON) = 0.5 Ω (typ.) • High forward transfer admittance : $|Y_{fs}| = 1.0 \text{ S}$ (typ.) • Low leakage current : $I_{DSS} = -100 \text{ } \mu\text{A}$ (max) ($V_{DS} = -60 \text{ V}$)

• Enhancement-mode : $V_{th} = -0.8 \sim -2.0 \text{ V (V}_{DS} = -10 \text{ V, I}_{D} = -1 \text{ mA)}$

Maximum Ratings (Ta = 25°C)

Characteris	stics	Symbol	Rating	Unit	
Drain-source voltage		V_{DSS}	-60	V	
Drain-gate voltage (Ro	_{SS} = 20 kΩ)	V_{DGR}	-60	V	
Gate-source voltage		V _{GSS}	±20	V	
Drain current	DC (Note 1)	I _D	-1	Α	
	Pulse (Note 1)	I_{DP}	-3	Α	
Drain power dissipation	١	P_{D}	0.9	W	
Single pulse avalanche energy (Note 2)		E _{AS}	249.6	mJ	
Avalanche current		I _{AR}	-1	Α	
Repetitive avalanche energy (Note 3)		E _{AR}	0.09	mJ	
Channel temperature		T _{ch}	150	°C	
Storage temperature range		T _{stg}	-55~150	°C	

5.1 max 0.75 max 1.0 max 0.6 max 1.27 2.54 9 1 2 3 1.SOURCE 2.DRAIN 3.GATE JEDEC TO-92MOD JEITA — TOSHIBA 2-5J1C

Weight: 0.36 g (typ.)

Thermal Characteristics

Characteristics	Symbol	Max	Unit
Thermal resistance, channel to ambient	R _{th (ch-a)}	138	°C/W

Note 1: Please use devices on condition that the channel temperature is below 150°C

Note 2: V_{DD} = -25 V, T_{ch} = 25 °C (initial), L = 339 mH, R_G = 25 Ω , I_{AR} = -1 A

Note 3: Repetitive rating: Pulse width limited by maximum channel temperature

This transistor is an electrostatic sensitive device.

Please handle with caution.

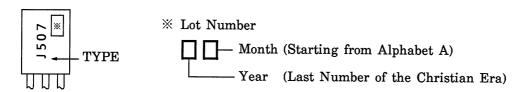
Electrical Characteristics (Ta = 25°C)

Charac	cteristics	Symbol	Test Condition	Min	Тур.	Max	Unit
Gate leakage cu	ırrent	I _{GSS}	V _{GS} = ±16 V, V _{DS} = 0 V	_	_	±10	μΑ
Drain cut-off cu	rrent	I _{DSS}	V _{DS} = -60 V, V _{GS} = 0 V	_	_	-100	μΑ
Drain-source br voltage	reakdown	V _{(BR) DSS}	$I_D = -10 \text{ mA}, V_{GS} = 0 \text{ V}$	-60	_	_	>
Gate threshold v	/oltage	V_{th}	$V_{DS} = -10 \text{ V}, I_D = -1 \text{ mA}$	-0.8	_	-2.0	٧
Drain-source ON resistance		Pro (OV)	V _{GS} = -4 V, I _D = -0.5 A		0.72	1.0	Ω
		R _{DS} (ON)	$V_{GS} = -10 \text{ V}, I_D = -0.5 \text{ A}$	_	0.5	0.7	12
Forward transfe	r admittance	Y _{fs}	$V_{DS} = -10 \text{ V}, I_D = -0.5 \text{ A}$	0.5	1.0	_	S
Input capacitano	ce	C _{iss}		_	170	_	
Reverse transfer capacitance		C _{rss}	V _{DS} = -10 V, V _{GS} = 0 V, f = 1 MHz	_	25	_	pF
Output capacitance		Coss	1		72	_	
Switching time	Rise time	t _r	$V_{GS} = 0V \qquad I_{D} = -0.5A \qquad V_{OUT}$ $V_{RL} = 60\Omega$ $V_{DD} = -30V$ $Duty \le 1\%, \ t_{W} = 10 \mu s$	_	20	_	
	Turn-on time	t _{on}		_	35	_	20
	Fall time	t _f		_	30	_	ns
	Turn-off time	t _{off}		_	135	_	
Total gate charge (Gate-source plus gate-drain)		Qg	V _{DD} ≈ -48 V, V _{GS} = -10 V,	_	5.6		
Gate-source charge		Q _{gs}	$I_D = -1 \text{ A}$		3.9		nC
Gate-drain ("miller") charge		Q _{gd}			1.7		

Source-Drain Ratings and Characteristics (Ta = 25°C)

Characteristics	Symbol	Test Condition	Min	Тур.	Max	Unit
Continuous drain reverse current (Note 1)	I _{DR}	_	_	_	-1	Α
Pulse drain reverse current (Note 1)	I _{DRP}	-	_	_	-3	Α
Forward voltage (diode)	V _{DSF}	$I_{DR} = -1 \text{ A, V}_{GS} = 0 \text{ V}$	1	_	1.5	V
Reverse recovery time	t _{rr}	I _{DR} = -1 A, V _{GS} = 0 V		58		ns
Reverse recovery charge	Q _{rr}	dI _{DR} / dt = 50 A / μs		72.5		nC

Marking



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